

Electronic Patent Application Fee Transmittal

Application Number:	10598469			
Filing Date:	17-May-2007			
Title of Invention:	Multilayer Substrate Manufacturing Method			
First Named Inventor/Applicant Name:	Takeshi Nakamura			
Filer:	Jan Felix Grasbon/Melvin Smith			
Attorney Docket Number:	14225-112US1 F1040898US00			
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Pages:				
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Miscellaneous-Filing:				
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Patent-Appeals-and-Interference:				
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